

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.

				August 1998		
FDC	6325L					
	grated Load	d Switch				
Genera	l Description			Features		
General Description This device is particularly suited for compact power management in portable electronic equipment where 2.5V to 8V input and 1.8A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SuperSOT TM -6 package.			 Features V_{DROP}=0.2V @ V_{IN}=5V, I_L=1.5A. R_(ON) = 0.13Ω V_{DROP}=0.2V @ V_{IN}=3.3V, I_L=1.2A. R_(ON) = 0.16Ω V_{DROP}=0.2V @ V_{IN}=2.5V, I_L=1A. R_(ON) = 0.18Ω. SuperSOTTM-6 package design using copper lead frame for superior thermal and electrical capabilities 			
	,",	190				
so	г-23 s	uperSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16
	37	5	Vin,R1 4		Vout,C1	
-	_{pin 1} rSOT [™] -6		ON/OFF 5	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 IN O Vout,C1 ON/OFF C	• • • • • • • • • • • • • • • • • • •
bsolu	_{pin 1} rSOT [™] -6		0N/0FF 5	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 IN O Vout,C1 ON/OFF C	
Absolu ymbol	rSOT [™] -6	Ratings T	ON/OFF 5	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 IN O ON/OFF C	
-	rSOT [™] -6	n Ratings T	ON/OFF 5	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 IN O ON/OFF C R2 FDC6325L	vo out
Absolı ymbol	rSOT [™] -6 ute Maximum Parameter Input Voltage Rar	nge ange	ON/OFF 5	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 IN ON/OFF C R2 FDC6325L 2.5 - 8	vvocepo ou1
	pin 1 rSOT ™-6 ute Maximum Parameter Input Voltage Rar On/Off Voltage R	nge ange - Con	ON/OFF 5 R1,C1 6 See Ap A = 25°C unless otherwise	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 Vout,C1 IN O ON/OFF C R2 FDC6325L 2.5 - 8 1.5 - 8	Vortex-
	pin 1 rSOT ™-6 ute Maximum Parameter Input Voltage Rar On/Off Voltage R Load Current Maximum Power	n Ratings T nge ange - Con - Pe Dissipation	$O N/OFF 5$ $R1,C1 6$ See Ap $A = 25^{\circ}C \text{ unless otherwise}$ tinuous (Note 1) ulsed (Note 1 & 3) (Note 2)	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 Vout,C1 IN O ON/OFF o R2 FDC6325L 2.5 - 8 1.5 - 8 1.8 5 0.7	Vortex-
	pin 1 rSOT ™-6 te Maximum Parameter Input Voltage Rar On/Off Voltage R Load Current	n Ratings T nge ange - Con - Pe Dissipation	$O N/OFF 5$ $R1,C1 6$ See Ap $A = 25^{\circ}C \text{ unless otherwise}$ tinuous (Note 1) ulsed (Note 1 & 3) (Note 2)	a1 a2 a1 a1 a1 a1 a1 a1 a1 a1 a1 a1	Vout,C1 IN O N/OFF C R2 FDC6325L 2.5 - 8 1.5 - 8 1.8 5	Units V V V V A
	pin 1 rSOT [™] -6 te Maximum Parameter Input Voltage Rai On/Off Voltage R Load Current Maximum Power Operating and St	Ratings T nge ange - Con - Pu Dissipation orage Temperatur harge Rating MIL-	$O N/OFF 5$ $R1,C1 6$ See Ap $A = 25^{\circ}C \text{ unless otherwise}$ tinuous (Note 1) ulsed (Note 1 & 3) (Note 2)	noted	Vout,C1 Vout,C1 IN O ON/OFF o R2 FDC6325L 2.5 - 8 1.5 - 8 1.8 5 0.7	Units
	pin 1 rSOT [™] -6 te Maximum Parameter Input Voltage Rai On/Off Voltage R Load Current Maximum Power Operating and St Electrostatic Disc	A Ratings T nge ange - Con - Pu Dissipation orage Temperatur harge Rating MIL- 00Ohm)	o N/O FF 5 R1, C1 6 See Ap tinuous (Note 1) ulsed (Note 1 & 3) (Note 2) re Range	noted	Vout,C1 Vout,C1 IN O ON/OFF C R2 FDC6325L 2.5 - 8 1.5 - 8 1.5 - 8 1.8 5 0.7 -55 to 150	✓ ✓ ○
	pin 1 rSOT ™-6 te Maximum Parameter Input Voltage Rat On/Off Voltage Rat On/Off Voltage R Load Current Maximum Power Operating and St Electrostatic Disc Model (100pf/150	A Ratings T nge ange - Con - Pe Dissipation orage Temperatur harge Rating MIL- 00hm) ICS	ON/OFF 5 R1,C1 6 See Ap See Ap tinuous (Note 1) ulsed (Note 1 & 3) (Note 2) re Range -STD-883D Human Body	noted	Vout,C1 Vout,C1 IN O ON/OFF C R2 FDC6325L 2.5 - 8 1.5 - 8 1.5 - 8 1.8 5 0.7 -55 to 150	✓ ✓ ○

© 1998 Fairchild Semiconductor Corporation

FDC6325L Rev.D1

Electrical Characteristics (T _A = 25°C unless otherwise noted)							
Symbol	Parameter	Conditions	Min	Тур	Max	Units	
OFF CHA	RACTERISTICS						
I _{FL}	Forward Leakage Current	$V_{IN} = 8 V, V_{ONOFF} = 0 V$			1	μA	
ON CHAR	ACTERISTICS (Note 3)						
V _{DROP}	Conduction Voltage Drop	$V_{IN} = 5 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}, I_{L} = 1.5 \text{ A}$		0.15	0.2	V	
		$V_{IN} = 3.3 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_L = 1.2 \text{ A}$		0.145	0.2		
		$V_{IN} = 2.5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_{L} = 1 \text{ A}$		0.13	0.2]	
R _(ON)	Q ₂ - Static On-Resistance	$V_{GS} = -5 \text{ V}, \ \text{I}_{\text{D}} = -1.8 \text{ A}$		0.115	0.13	Ω	
		$V_{GS} = -3.3 \text{ V}, I_{D} = -1.6 \text{ A}$		0.13	0.16		
		$V_{GS} = -2.5 \text{ V}, I_{D} = -1.5 \text{ A}$		0.155	0.18		
IL.	Load Current	$V_{\text{DROP}} = 0.13 \text{ V}, \text{ V}_{\text{IN}} = 5 \text{ V}, \text{ V}_{\text{ONOFF}} = 3.3 \text{ V}$	1			А	
		$V_{\text{DROP}} = 0.16 \text{ V}, \text{ V}_{\text{IN}} = 3.3 \text{ V}, \text{ V}_{\text{ONOFF}} = 3.3 \text{ V}$	1]	
1		$V_{\text{DROP}} = 0.2 \text{ V}, V_{\text{IN}} = 2.5 \text{V}, V_{\text{ONOFF}} = 3.3 \text{ V}$	1]	

Notes:

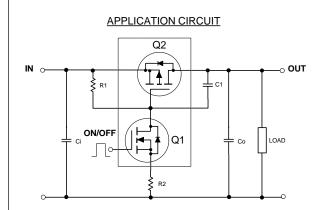
1. V_{IN} =8V, $V_{ON/OFF}$ =8V, T_A =25°C

2. R_{eJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface

of the drain pins. $R_{_{\theta JC}}$ is guaranteed by design while $R_{_{\theta CA}}$ is determined by the user's board design.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.

FDC6325L Load Switch Application

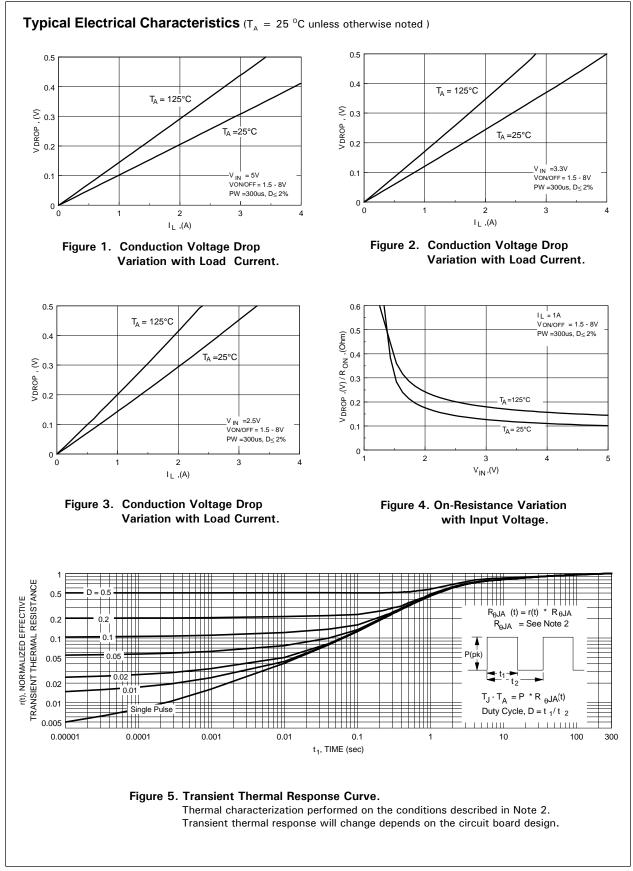


External Component Recommendation

For Co £ 1uF applications:

First select R2, 100 - 1kW, for Slew Rate control. C1 \pm 1000pF can be added in addition to R2 for further In-rush current control.

Then select R1 such that R1/R2 ratio maintains between 10 - 100. R1 is required to turn Q2 off. For SPICE simulation, users can download a "FDC6325L.MOD" Spice model from Fairchild Web Site at www.fairchildsemi.com



FDC6325L Rev.D1

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACExTM CoolFETTM CROSSVOLTTM E²CMOSTM FACTTM FACT Quiet SeriesTM FAST[®] FAST[®] FASTrTM GTOTM HiSeCTM ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[™] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8

TinyLogic™ UHC™ VCX™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC